

## FEATURES



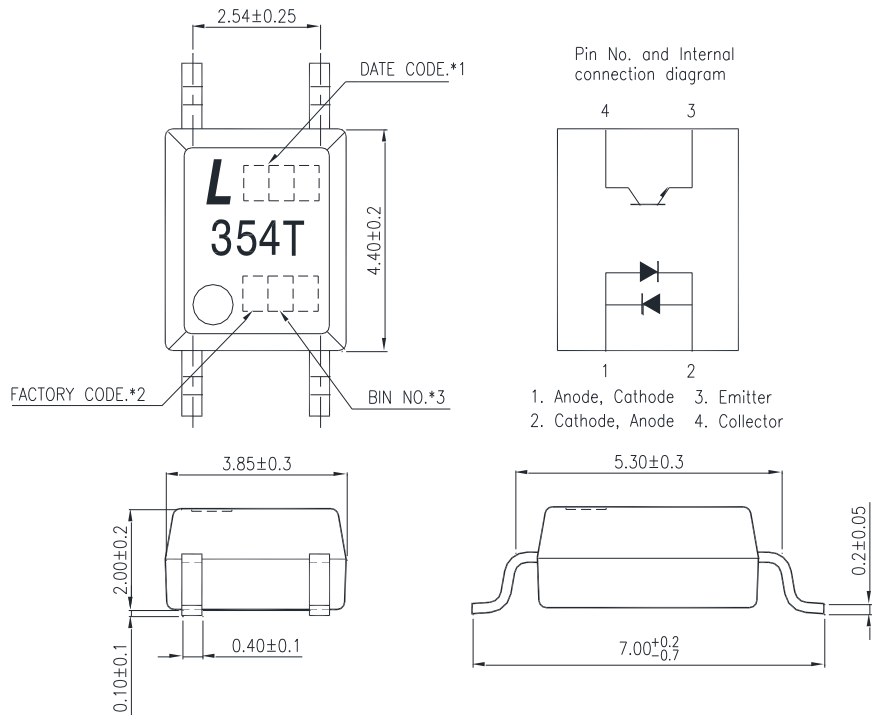
- \* Current transfer ratio  
( CTR : MIN. 20% at  $I_F = \pm 1\text{mA}$ ,  $V_{CE} = 5\text{V}$  )
- \* Isolation voltage between input and output LTV-354T  
(  $V_{iso} = 3,750\text{V}_{rms}$  )
- \* Mini-flat package :  
2.0mm profile : LTV-354T
- \* UL, CUL, CSA, FIMKO, NEMKO, DEMKO, SEMKO approved
- \* RoHS compliance

## APPLICATIONS

- \* Hybrid substrates that require high density mounting.
- \* Programmable controllers
- \* System appliance, measuring instruments

## OUTLINE DIMENSIONS

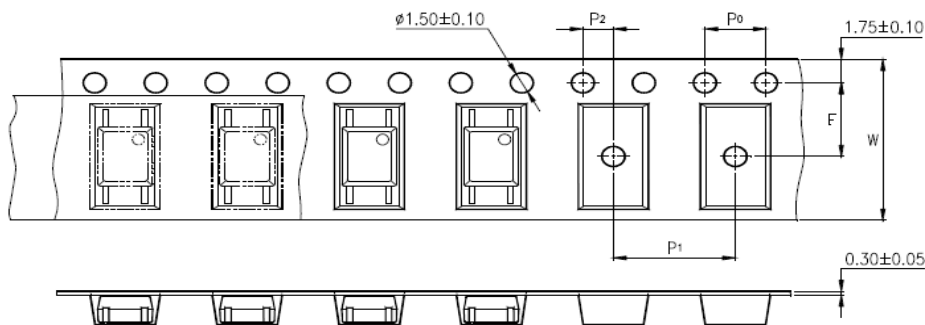
### LTV-354T :



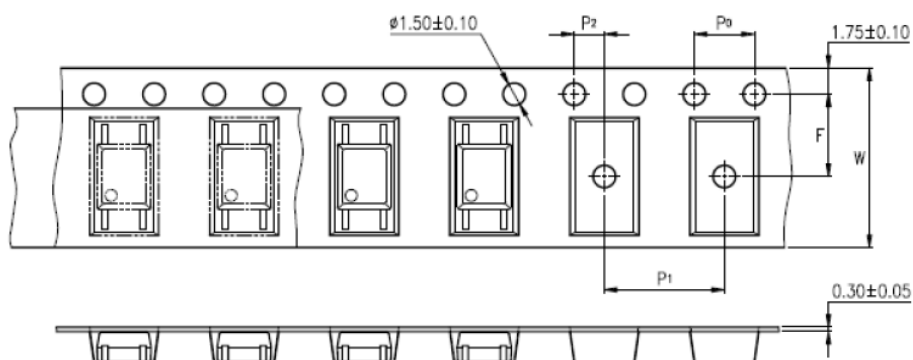
- \*1. 3-digit date code.
- \*2. Factory identification mark shall be marked (W: China-CJ, X: China-TJ, Y: Thailand).
- \*3. Rank shall be or shall not be marked.

## TAPING DIMENSIONS

### TP1 MINI FLAT (3000pcs/reel) : Suffix "-TP1"



### TP MINI FLAT (3000pcs/reel) : Suffix "-TP"



### Content Quantity

Model	Reel volume (pcs/Reel)	Inner Box volume (Reel/Box)	Outer carton volume (Box/Carton)	Total volume (pcs/outer carton)
MFP TP/TP1	3000	2	10	60000

Description	Symbol	Dimensions in mm ( inches )
Tape wide	W	$12 \pm 0.3$ ( .47 )
Pitch of sprocket holes	$P_0$	$4 \pm 0.1$ ( .15 )
Distance of compartment	F	$5.5 \pm 0.1$ ( .217 )
Distance of compartment to compartment	$P_2$	$2 \pm 0.1$ ( .079 )
Distance of compartment to compartment	$P_1$	$8 \pm 0.1$ ( .315 )

**ABSOLUTE MAXIMUM RATING**

( Ta = 25°C )

PARAMETER		SYMBOL	RATING	UNIT
INPUT	Forward Current	I <sub>F</sub>	±50	mA
	Power Dissipation	P	70	mW
OUTPUT	Collector - Emitter Voltage	V <sub>CEO</sub>	35	V
	Emitter - Collector Voltage	V <sub>ECO</sub>	6	V
	Collector Current	I <sub>c</sub>	50	mA
	Collector Power Dissipation	P <sub>c</sub>	150	mW
Total Power Dissipation		P <sub>tot</sub>	170	mW
*1	Isolation Voltage	V <sub>iso</sub>	3,750	V <sub>rms</sub>
Operating Temperature		T <sub>opr</sub>	-30~ +110	°C
Storage Temperature		T <sub>stg</sub>	-55 ~ +150	°C
*2	Soldering Temperature	T <sub>sol</sub>	260	°C

\*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

\*2. For 10 Seconds

## ELECTRICAL - OPTICAL CHARACTERISTICS

( Ta = 25°C )

PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
INPUT	Forward Voltage	$V_F$	—	1.2	1.4	V	$I_F = \pm 20\text{mA}$
	Terminal Capacitance	$C_t$	—	30	250	pF	$V = 0, f = 1\text{KHz}$
OUTPUT	Collector Dark Current	$I_{CEO}$	—	—	100	nA	$V_{CE} = 20\text{V}, I_F = 0$
	Collector-Emitter Breakdown Voltage	$BV_{CEO}$	35	—	—	V	$I_C = 0.1\text{mA}$ $I_F = 0$
	Emitter-Collector Breakdown Voltage	$BV_{ECO}$	6	—	—	V	$I_E = 10\mu\text{A}$ $I_F = 0$
TRANSFER CHARACTERISTICS	Collector Current	$I_C$	0.2	—	4	mA	$I_F = \pm 1\text{mA}$ $V_{CE} = 5\text{V}$
	*1 Current Transfer Ratio	CTR	20	—	400	%	
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	0.1	0.2	V	$I_F = \pm 20\text{mA}$ $I_C = 1\text{mA}$
	Isolation Resistance	$R_{iso}$	$5 \times 10^{10}$	$1 \times 10^{11}$	—	$\Omega$	DC500V 40 ~ 60% R.H.
	Floating Capacitance	$C_f$	—	0.6	1	pF	$V = 0, f = 1\text{MHz}$
	Response Time (Rise)	$t_r$	—	4	18	$\mu\text{s}$	$V_{CE} = 2\text{V}, I_C = 2\text{mA}$ $R_L = 100\Omega$
	Response Time (Fall)	$t_f$	—	3	18	$\mu\text{s}$	

$$*1 \text{ CTR} = \frac{I_C}{I_F} \times 100\%$$

**RANK TABLE OF CURRENT TRANSFER RATIO CTR**

<b>MODEL NO.</b>	<b>RANK MARK</b>	<b>CTR ( % )</b>
LTV-354T	A	50 ~ 150
	A or No mark	20 ~ 400

<b>CONDITIONS</b>	$I_F = \pm 1 \text{ mA}$ $V_{CE} = 5 \text{ V}$ $T_a = 25 \text{ }^\circ\text{C}$
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## CHARACTERISTICS CURVES

Fig.1 Forward Current vs. Ambient Temperature

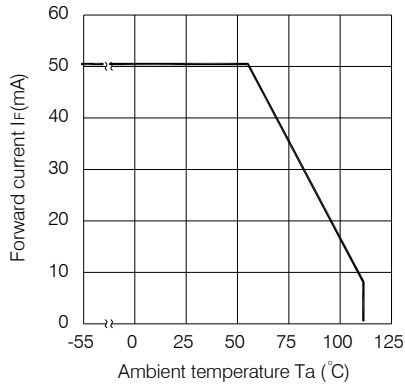


Fig.2 Collector Power Dissipation vs. Ambient Temperature

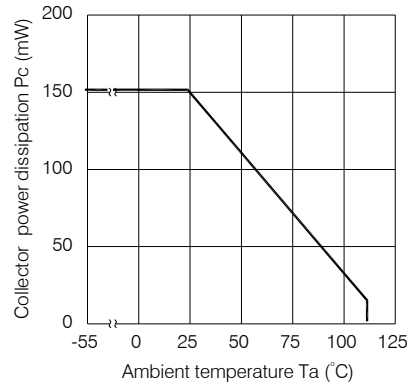


Fig.3 Collector-emitter Saturation Voltage vs. Forward Current

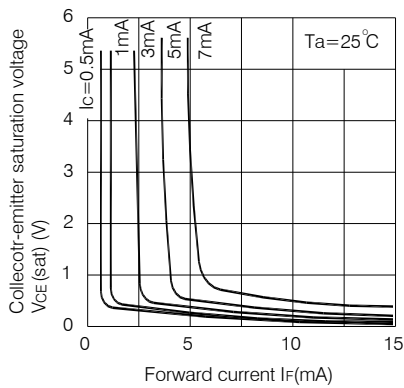


Fig.4 Forward Current vs. Forward Voltage

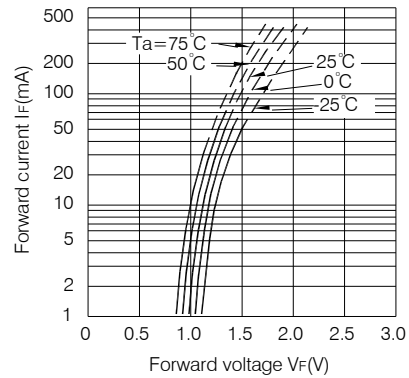


Fig.5 Current Transfer Ratio vs. Forward Current

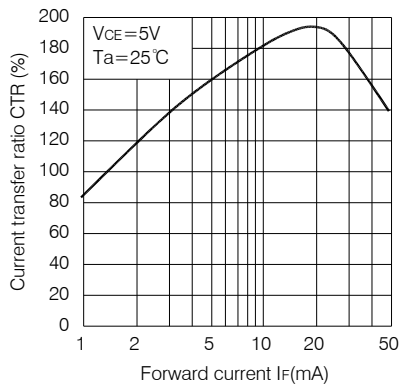
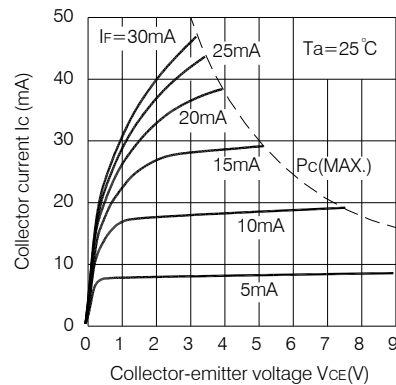


Fig.6 Collector Current vs. Collector-emitter Voltage



## CHARACTERISTICS CURVES

Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

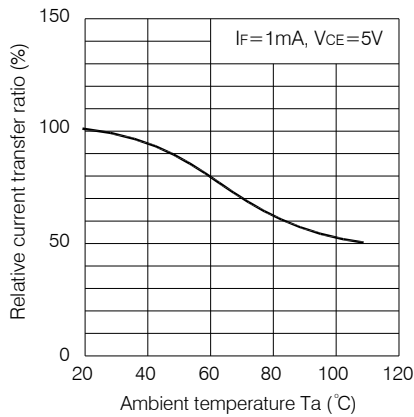


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

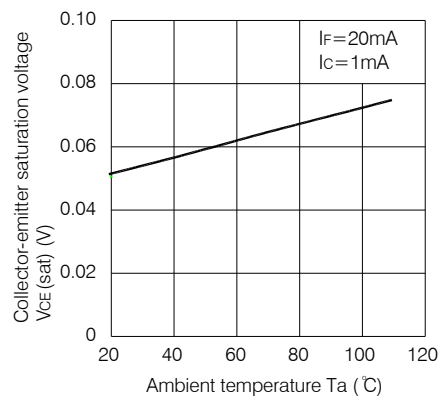


Fig.9 Collector Dark Current vs. Ambient Temperature

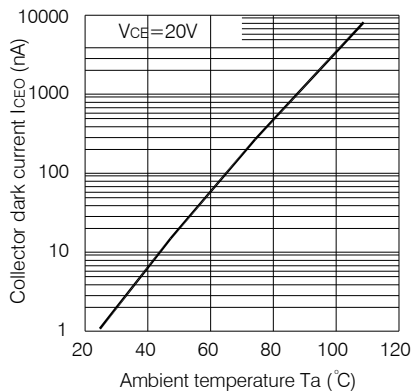


Fig.10 Response Time vs. Load Resistance

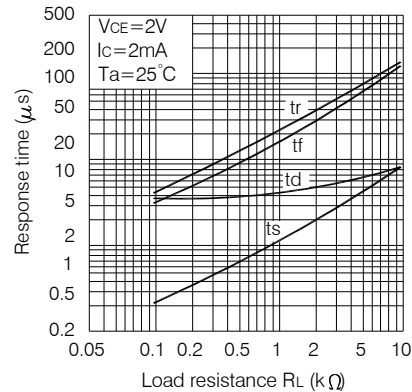
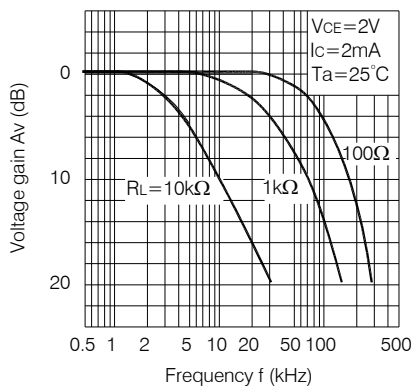
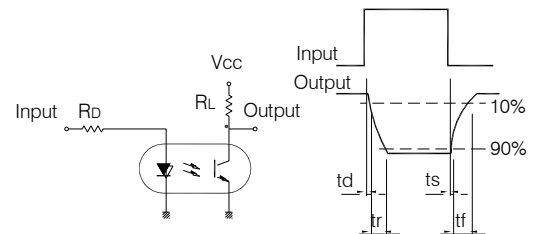


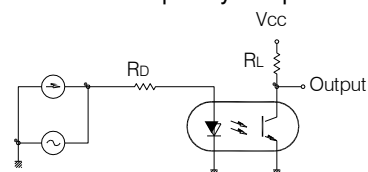
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



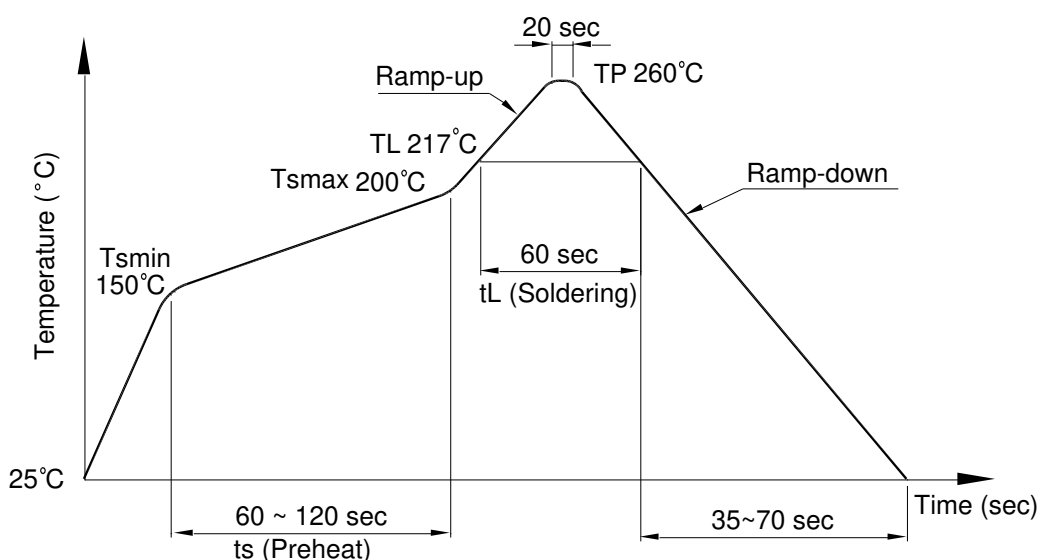


## TEMPERATURE PROFILE OF SOLDERING REFLOW

(1) IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below.

Profile item	Conditions
Preheat - Temperature Min ( $T_{Smin}$ ) - Temperature Max ( $T_{Smax}$ ) - Time (min to max) (ts)	150°C 200°C 90±30 sec
Soldering zone - Temperature ( $T_L$ ) - Time ( $t_L$ )	217°C 60 sec
Peak Temperature ( $T_P$ )	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



### TEMPERATURE PROFILE OF SOLDERING REFLOW

#### (2) Wave soldering (JEDEC22A111 compliant)

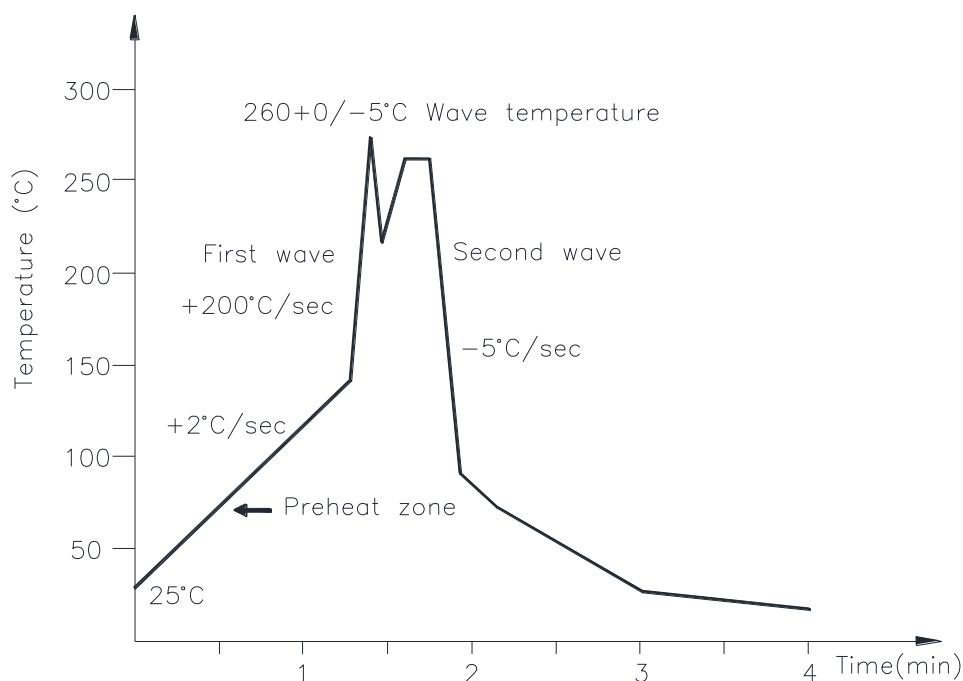
One time soldering is recommended within the condition of temperature.

Temperature:  $260 \pm 0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to  $140^{\circ}\text{C}$

Preheat time: 30 to 80 sec.



#### (3) Hand soldering by soldering iron

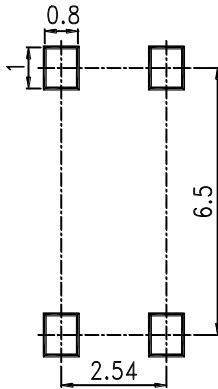
Allow single lead soldering in every single process. One time soldering is recommended.

Temperature:  $380 \pm 0/-5^{\circ}\text{C}$

Time: 3 sec max.

## RECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

Unit : mm



## **TEMPERATURE PROFILE OF SOLDERING REFLOW**

- Lite-On is continually improving the quality, reliability, function or design and Lite-On reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.